### SUPER FAST GLASS PASSIVATED RECTIFIERS

# **FEATURES:**

- Low forward voltage drop
- High current capability
- High reliability
- High surge current capability
- Good for switching mode application

### MECHANICAL DATA

Case: Molded plastic

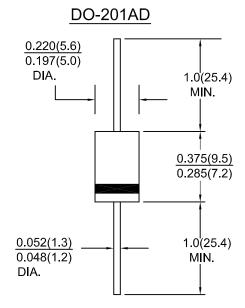
Epoxy: UL 94V-0 rate flame retardant

Lead: Axial leads, solderable per MIL-STD-202,

Method 208 guaranteed

Polarity: Color band denotes cathode end

Mounting Position : Any Weight : 1.10 grams



Dimensions in inches and (millimeters)

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25 °C ambient temp. unless otherwise specified.

Single phase, half sine wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20 %.

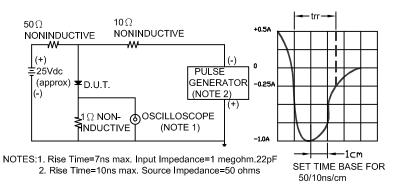
Characteristic	Symbol	SF 31G	SF 32G	SF 33G	SF 34G	SF 35G	SF 36G	SF 37G	Units
Maximum recurrent peak reverse voltage	Vrrm	50	100	150	200	300	400	600	Volts
Maximum RMS voltage	VRMS	35	70	105	140	210	280	420	Volts
Maximum DC blocking voltage	VDC	50	100	150	200	300	400	600	Volts
Maximum average forward rectified current .375"(9.5mm) lead length at Ta=55 ℃	I(AV)	3.0							Amps
Peak forward surge current ,8.3ms single half sine-wave superimposed on rated load(JEDEC Method)	IFSM	125						Amps	
Maximum instantaneous forward voltage at 3.0 A	VF	1.00			1.30		1.70	Volts	
Maximum instantaneous reverse current Ta=25 ℃ at rated DC blocking voltage Ta=125 ℃	ĪR	5.0 100						μ Α	
Maximum reverse recovery time (note 1)	trr	35						nS	
Typical junction capacitance (note 2)	Cj	50						pF	
Operating and storage temperature range	Tj,Tstg	-65 to +150							ဗ

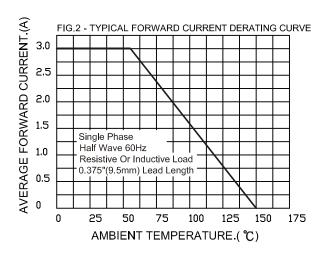
Notes: 1. Reverse recovery test condition: I F=0.5A; IR=1.0A; IRR=0.25A

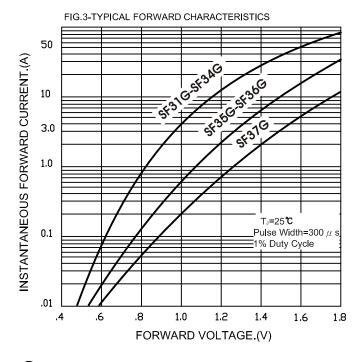
2. Measured 1MHz and applied reverse voltage of 4.0V DC

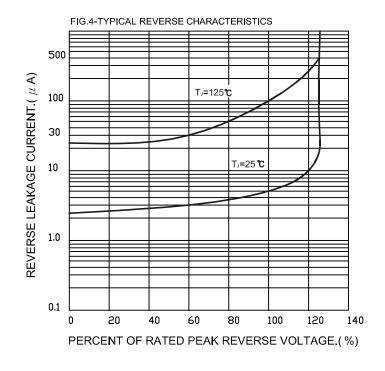
### RATINGS AND CHARACTERISTIC CURVES

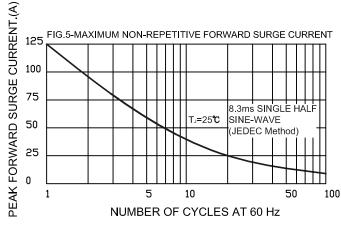
FIG.1-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

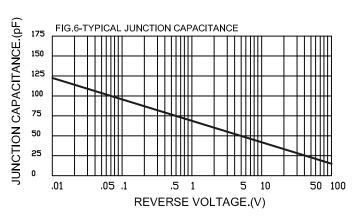












# SF31G THRU SF37G

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